

INCHANGE SEMICONDUCTOR

isc P-Channel MOSFET Transistor

IRF9Z34NS

·FEATURES

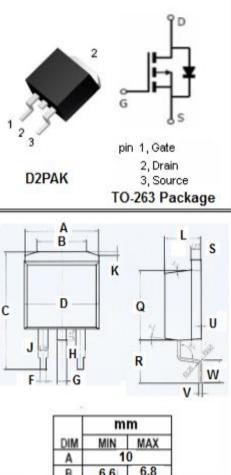
- Static drain-source on-resistance:
 - RDS(on)≤100mΩ(@V_{GS}= -10V; I_D= -10A)
- Advanced trench process technology
- 100% avalanche tested
- Minimum Lot-to-Lot variations for robust device performance and reliable operation

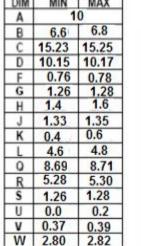
APPLICATIONS

• Fast switching application.

• ABSOLUTE MAXIMUM RATINGS(Ta=25°C)

| SYMBOL | PARAMETER | VALUE | UNIT | | | | |
|-------------------------|-------------------------------------|---------|------|--|--|--|--|
| V _{DSS} | Drain-Source Voltage | -55 | V | | | | |
| V _{GS} | Gate-Source Voltage | ±20 | V | | | | |
| ID | Drain Current-Continuous | -19 | А | | | | |
| P _D | Total Dissipation @Tc=25℃ | 68 | W | | | | |
| Tj | Max. Operating Junction Temperature | -55~175 | °C | | | | |
| T _{stg} | Storage Temperature | -55~175 | °C | | | | |
| THERMAL CHARACTERISTICS | | | | | | | |
| SYMBOL | PARAMETER | MAX | UNIT | | | | |
| Rth(j-c) | Channel-to-case thermal resistance | 2.2 | °C/W | | | | |





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ELECTRICAL CHARACTERISTICS

T_c=25℃ unless otherwise specified

| SYMBOL | PARAMETER | CONDITIONS | MIN | МАХ | UNIT |
|---------------------|--------------------------------|--|-----|------|------|
| BV _{DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V; I _D = -250 μ A | -55 | | V |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} ; I _D = -250 μ A | -2 | -4 | V |
| R _{DS(on)} | Drain-Source On-Resistance | V _{GS} = -10V; I _D = -10A | | 100 | mΩ |
| Igss | Gate-Source Leakage Current | V _{GS} = ±20V; V _{DS} = 0V | | ±100 | nA |
| IDSS | Drain-Source Leakage Current | V _{DS} = -55V; V _{GS} = 0V | | -25 | μA |
| V _{SD} | Diode forward voltage | I _s = -10A, V _{GS} = 0V | | 1.6 | V |



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